

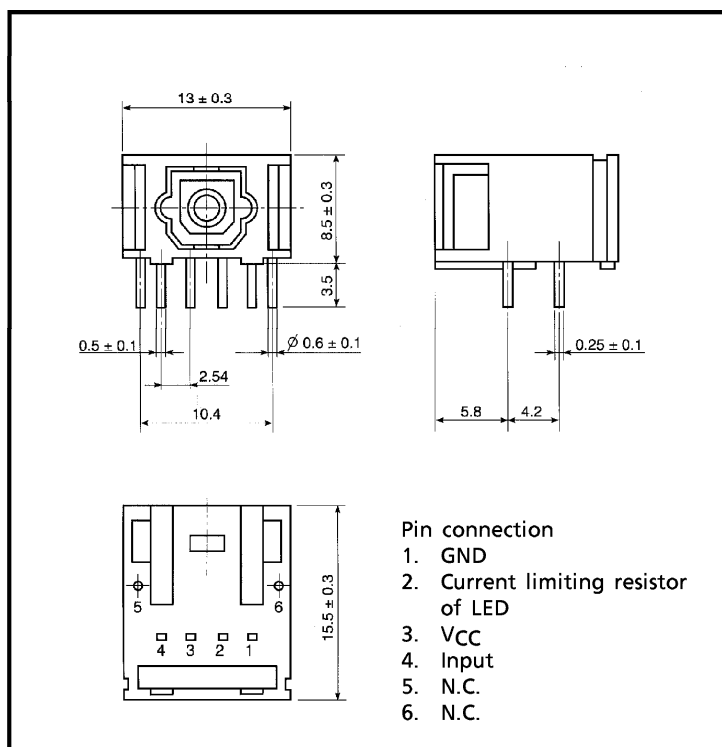
FIBER OPTIC TRANSMITTING MODULE

TOTX195

FIBER OPTIC TRANSMITTING MODULE FOR
SIMPLEX DIGITAL SIGNAL TRANSMISSION

Unit in mm

- Data rate : DC to 10 Mb/s (NRZ code)
- Transmission distance : Up to 50 m
- TTL interface
- LED is driven by Differential circuit.



1. Maximum Ratings ($T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	RATING	UNIT
Storage Temperature	T_{stg}	-40 to 85	$^\circ\text{C}$
Operating Temperature	T_{opr}	-40 to 85	$^\circ\text{C}$
Supply Voltage	V_{CC}	-0.5 to 7	V
Input Voltage	V_{IN}	-0.5 to $V_{\text{CC}} + 0.5$	V
Soldering Temperature	T_{sol}	260 ⁽¹⁾	$^\circ\text{C}$

Note ⁽¹⁾ Soldering time ≤ 3 s (More than 1 mm apart from the package).

Handling precaution : The LEDs used in this product contain GaAs (Gallium Arsenide). Care must be taken to protect the safety of people and the environment when scrapping or terminal processing.

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- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.
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2. Recommended Operating Conditions

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V_{CC}	4.75	5.0	5.25	V
High Level Input Voltage	V_{IH}	2.0	—	V_{CC}	V
Low Level Input Voltage	V_{IL}	0	—	0.8	V

3. Electrical and Optical Characteristics ($T_a = 25^\circ\text{C}$, $V_{CC} = 5\text{ V}$)

PARAMETER	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Data Rate		NRZ code ⁽²⁾	DC	—	10	Mb/s
Transmission Distance		Using APF ⁽³⁾ and TORX194	0.2	—	50	m
Pulse Width Distortion ⁽⁴⁾	Δtw	Using APF and TORX194 Pulse width 100 ns Pulse cycle 200 ns, $C_L = 10\text{ pF}$	−30	—	30	ns
Fiber Output Power	P_f	APF 1 m, $R = 1.2\text{ k}\Omega$ ⁽⁵⁾	−11	—	−6	dBm
Peak Emission Wavelength	λ_p		—	670	—	nm
Current Consumption	I_{CC}	$R = 1.2\text{ k}\Omega$	—	40	55	mA
High Level Input Voltage	V_{IH}		2.0	—	—	V
Low Level Input Voltage	V_{IL}		—	—	0.8	V
High Level Input Current	I_{IH}	$V_I = 2.7\text{ V}$	—	—	20	μA
Low Level Input Current	I_{IL}	$V_I = 0.4\text{ V}$	—	—	−0.4	mA

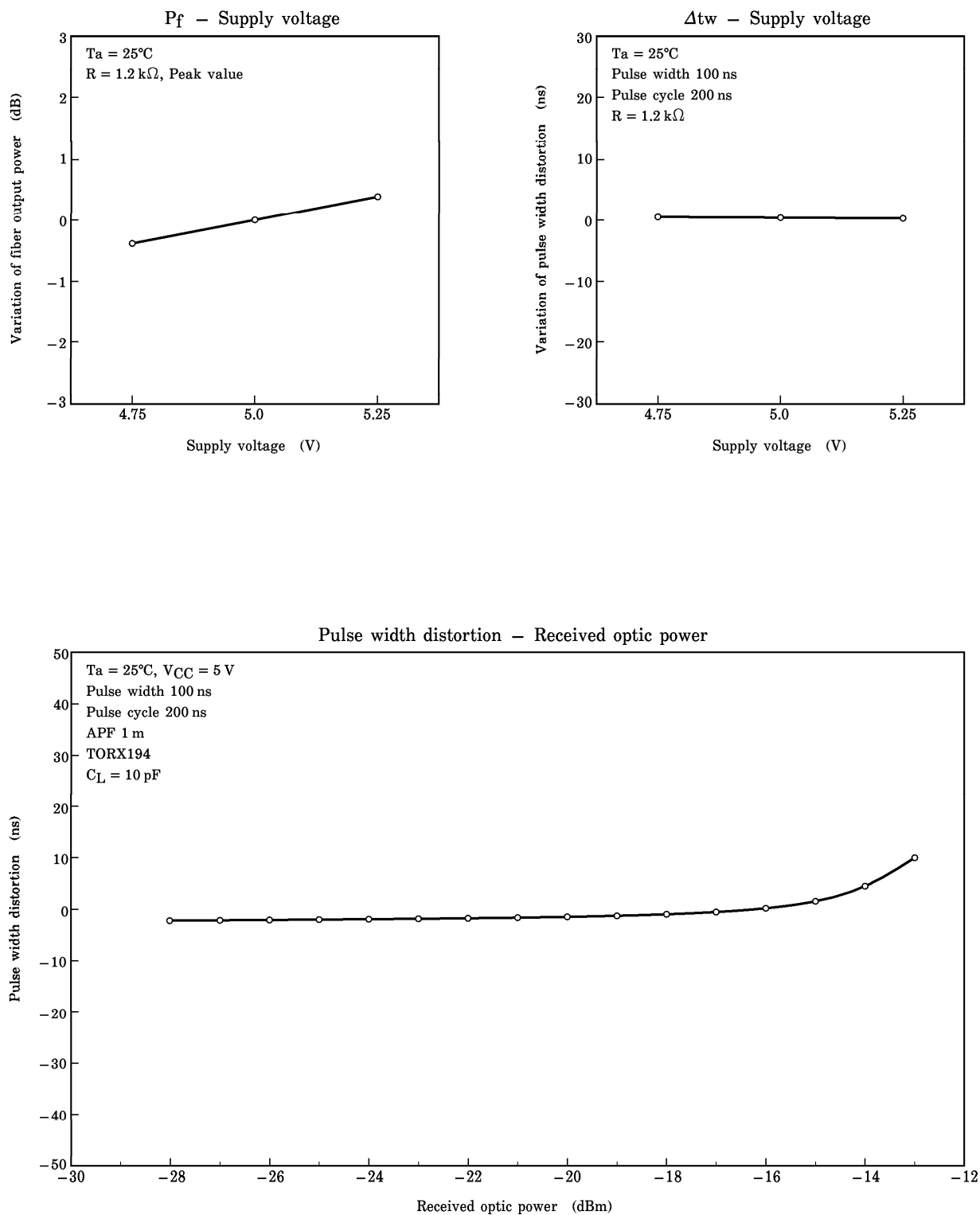
⁽²⁾ LED is on when input signal is high level, it is off when low level.

⁽³⁾ All Plastic Fiber (980 / 1000 μm) with polished surface.

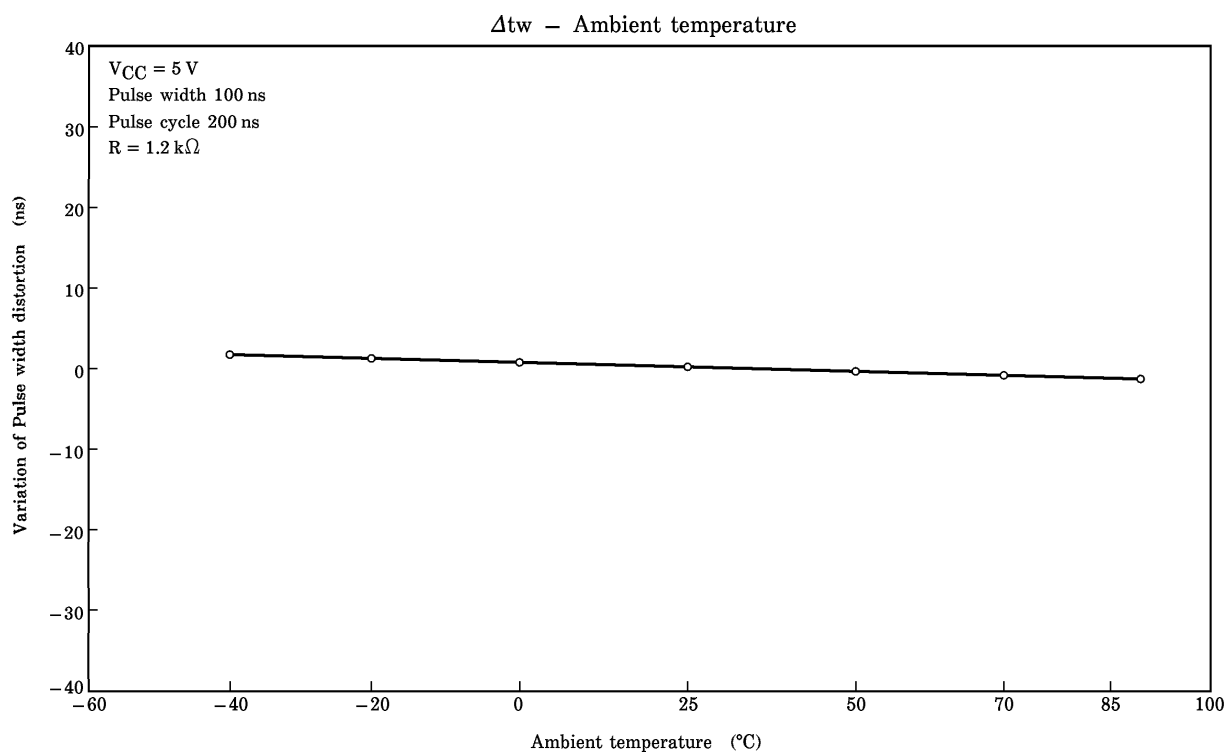
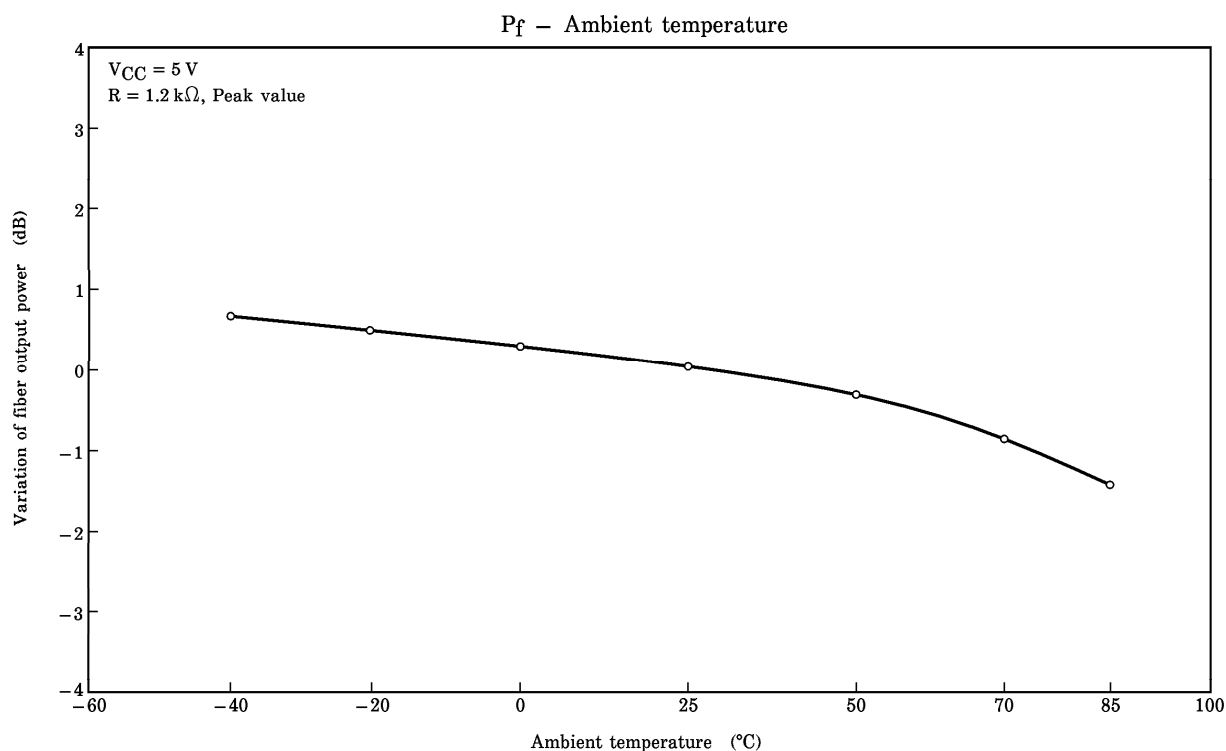
⁽⁴⁾ Between input of TOTX195 and output of TORX194.

⁽⁵⁾ Measure with a standard optical fiber with fiber optic connectors. Valued by peak.

4. Example of Typical Characteristics

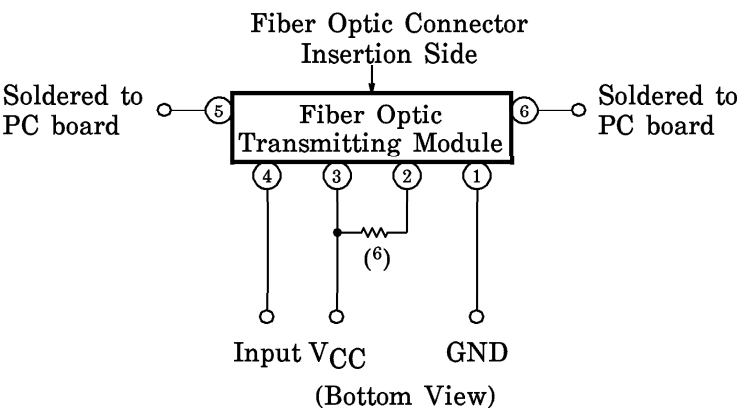


Note. (6) There give characteristic examples, and its values are not guaranteed.



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5. Application Circuit



Note (6) Select a resistor value as follows :

TRANSMISSION DISTANCE (m)	RESISTOR (Ω)
0.2 to 10	17.8 k
10 to 30	6.2 k
30 to 50	1.2 k

6. Applicable Optical Fiber with Fiber Optic Connectors

TOCP100-□□B, TOCP155-□□B, TOCP100P-□□B, TOCP155P-□□B

7. Precautions during use

(1) Maximum rating

The maximum ratings are the limit values which must not be exceeded during operation of device. None of these rating value must not be exceeded. If the maximum rating value is exceeded, the characteristics of devices may never be restored properly. In extreme cases, the device may be permanently damages.

(2) Lifetime of light emitters

If an optical module is used for a long period of time, degeneration in the characteristics will mostly be due to a lowering of the fiber output power (Pf). This is caused by the degradation of the optical output of the LEDs used as the light source. The cause of degradation of the optical output of the LEDs may be defects in wafer crystallization or mold resin stress. The detailed causes are, however, not clear.

The lifetime of light emitters is greatly influenced by the operating conditions and the environment in which it is used as well as by the lifetime characteristics unique to the device type. Thus, when a light emitting device and its operating conditions determined, Toshiba recommend that lifetime characteristics be checked.

Depending on the environment conditions, Toshiba recommend that maintenance such as regular checks of the amount of optical output in accordance with the condition of operating environment.

(3) Soldering

Optical modules are comprised of internal semiconductor devices. However, in principle, optical modules are optical components. During soldering, ensure that flux does not contact with the emitting surface or the detecting surface. Also ensure that proper flux removal is conducted after soldering.

Some optical modules come with a protective cap. The protective cap is used to avoid malfunction when the optical module is not in use. Note that it is not dust or waterproof. As mentioned before, optical modules are optical components. Thus, in principle, soldering where there may be flux residue and flux removal after soldering is not recommended. Toshiba recommend that soldering be performed without the optical module mounted on the board. Then, after the board has been cleaned, the optical module should be soldered on to the board manually.

If the optical module cannot be soldered manually, use non-halogen (chlorine-free) flux and make sure, without cleaning, there is no residue such as chlorine. This is one of the ways to eliminate the effects of flux. In such a cases, be sure to check the devices' reliability.

(4) Vibration and shock

This module is plastic sealed and has its wire fixed by resin. This structure is relatively resistant to vibration and shock. In actual equipment, there are sometime cases in which vibration, shock, or stress is applied to soldered parts or connected parts, resulting in lines cut. A care must be taken in the design of equipment which will be subject to high levels of vibration.

(5) Attaching the fiber optic transmitting module

Solder the fixed pins (pins 4 and 5) of the fiber optic transmitting module TOTX195 to the printed circuit board in order to fix it to the board.

(6) Solvent

When using solvent for flux removal, do not use a high acid or high alkali solvent. Be careful not to pour solvent in to the optical connector ports. If solvent is inadvertently poured in to them, clean it off using cotton tips.

(7) Protective cap

When the TOTX195 is not in use, attach the protective cap.

(8) Supply voltage

Use the supply voltage within the recommended operating condition ($V_{CC} = 5 \pm 0.25 \text{ V}$). Make sure that supply voltage does not exceed the maximum rating value of 7 V, even for an instant.

(9) Input voltage

If a voltage exceeding the maximum rating value ($V_{CC} + 0.5 \text{ V}$) is applied to the transmitter input, the internal IC may suffer damage. If there is a possibility that excessive voltage due to surges may be added to the input terminal, insert a protective circuit.

(10) Soldering condition

Solder at 260°C or less for no more than three seconds.

(11) Precautions when disposing of devices and packing materials.

When disposing devices and packing materials, follow the procedures stipulated by local regulations in order to protect the environment against contamination.

Compound semiconductors such as GaAs are used as LED materials in this module. When devices are disposed of, worker safety and protection of the environment must be taken into account.

(12) Precautions during use

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